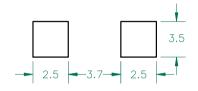
MGV06034R7M-10

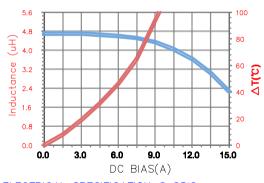
PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	\pm	0.30
С	3.00	\pm	0.30
D	2.90	±	0.30

 1.60 ± 0.50

LAND PATTERNS FOR REFLOW SOLDERING

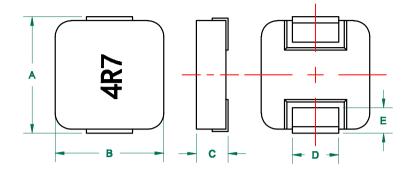




ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max	
INDUCTANCE (uH)				
L @ 100 KHz/0.25V	3.76 4.7		5.64	
± 20%				
DCR (Ω)			0.040	

Saturation Current ³ Isat (A)	10.00
Temperature Rise Current Irms ⁴(A)	5.50





UNCONTROLLED DOCUMENT





NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS $\leq 25\%$ FROM ITS VALUE WITHOUT CURRENT (Ta=25 ± 5 °C).
- 4.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE (Δ T \leq 40°C) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm.			This print is the property of Lai						
				subject to return upon request			_	=	
				with the understanding that no			a	irt	
				copies shall be made without the written consent of Laird Tech. A				oLOGI	
F	CHANGE NOTE 2.3.4	06/24/12	QIU	rights to design or invention are		-			
Ε	REVISE DIMENSIONS AND ADD CURVE	06/27/12	QIU	reserved.					
D	CORRECT MARKING AND DIMENSION	03/21/12	QIU	PROJECT/PART NUMBER:	- 1	REV	PART TY		DRAWN BY:
С	C CHANGE FROM 3	03/16/12	QIU	MGV06034R7M-10	ן	F		WER ICTOR	QIU
В	CHG IAMENSION AND ADD NOTE 2&3	02/21/12	QIU	DATE: 12/19/11	SCA	LE: N	TS	SHEET:	
Α	ORIGINAL DRAFT	12/19/11	QIU		TOO		13		
REV	DESCRIPTION	DATE	INT	MGV06034R7M-10-F		- " -	-	2	of 2